

Part Number: 786463001

Product Description: micro-SIM Card Socket without Detect Switch, 1.45mm Height, Push-Pull Eject, Surface Mount, 6 Circuits, Low-

Halogen, Lead-Free Series Number: 78646

Status: Active

Product Category: Memory / SIM Card

Connectors



Documents & Resources

Drawings

786463001_sd.pdf

3D Models and Design Files

786463001_stp.zip EE-78646-001-001.pdf

Specifications

PS-78646-001-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 33
China RoHS	©
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2024)4144-DC (27 June 2024)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C

- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	Memory / SIM Card Connectors
Series	78646
Description	micro-SIM Card Socket without Detect Switch, 1.45mm Height, Push-Pull Eject, Surface Mount, 6 Circuits, Low-Halogen, Lead-Free
Product Family	SD and SIM Memory Card Sockets
Product Name	micro-SIM
Style	Push-Pull
UPC	884982798830

Electrical

Current - Maximum per Contact	0.5A
Voltage - Maximum	15V DC

Physical

Card Detection Switch	No
Card Entry Location	Front
Circuits (Loaded)	6
Circuits (maximum)	6
Durability (mating cycles max)	1500
Ejector Button Side	N/A
Material - Contact	Copper Alloy
Material - Plating Mating	Gold
Material - Shell	Stainless Steel
Net Weight	0.243/g
Packaging Type	Embossed Tape on Reel

PCB Locator	No
PCB Retention	Yes
Pitch - Mating Interface	1.27mm
Temperature Range - Operating	-30° to +85°C
Termination Interface Style	Surface Mount

Solder Process Data

Max-Duration	10
Lead-Free Process Capability	REFLOW
Max-Cycle	3
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
Mates With	micro-SIM Card

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